

## PATENT ASSIGNMENT COVER SHEET

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Stylesheet Version v1.2

EPAS ID: PAT2746103

SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1"><thead><tr><th>Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>YONGHAO XIU</td><td>01/13/2014</td></tr><tr><td>NISHA ANANTHAKRISHNAN</td><td>01/15/2014</td></tr><tr><td>YIQUN BAI</td><td>01/14/2014</td></tr><tr><td>ARJUN KRISHNAN</td><td>01/15/2014</td></tr></tbody></table>		Name	Execution Date	YONGHAO XIU	01/13/2014	NISHA ANANTHAKRISHNAN	01/15/2014	YIQUN BAI	01/14/2014	ARJUN KRISHNAN	01/15/2014
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RECEIVING PARTY DATA											
<table border="1"><tr><td>Name:</td><td>INTEL CORPORATION</td></tr><tr><td>Street Address:</td><td>2200 MISSION COLLEGE BLVD.</td></tr><tr><td>City:</td><td>SANTA CLARA</td></tr><tr><td>State/Country:</td><td>CALIFORNIA</td></tr><tr><td>Postal Code:</td><td>95054</td></tr></table>		Name:	INTEL CORPORATION	Street Address:	2200 MISSION COLLEGE BLVD.	City:	SANTA CLARA	State/Country:	CALIFORNIA	Postal Code:	95054
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PROPERTY NUMBERS Total: 1											
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Application Number:	14135236										
CORRESPONDENCE DATA											
Fax Number:											
Phone:	612-373-6900										
Email:	ncundall@slwip-rc.com										
<i>Correspondence will be sent via US Mail when the email attempt is unsuccessful.</i>											
Correspondent Name:	SCHWEGMAN, LUNDBERG & WOESSNER/INTEL										
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Address Line 4:	MINNEAPOLIS, MINNESOTA 55402										
ATTORNEY DOCKET NUMBER:	884.N53US1										
NAME OF SUBMITTER:	NANCY CUNDALL										
Signature:	/Nancy Cundall/										

Date:

02/27/2014

Total Attachments: 3

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RECORDATION FORM COVER SHEET  
PATENTS ONLY

Atty Ref/Docket No.: 884.N53US1

Patent and Trademark Office

To the Director of the U.S. Patent and Trademark Office: Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):

Yonghao Xiu, Nisha Ananthakrishnan, Yiqun Bai, Arjun Krishnan

Additional name(s) of conveying party(ies) attached?

☐ Yes ☒ No

3. Nature of conveyance:

☒ Assignment

☐ Merger

☐ Security Agreement ☐ Change of Name

☐ Other

Execution Date: January 13, 2014, January 15, 2014,  
January 14, 2014, January 15, 2014

2. Name and address of receiving party(ies):

Name: Intel Corporation

Street Address: 2200 Mission College Blvd.

City: Santa Clara State: CA Zip: 95054

Country: United States of America

Additional name(s) & address(es) attached? ☐ Yes ☒ No

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is:

A. Patent Application No.(s)

B. Patent No.(s)

Serial No. 14/135,236

Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Michael R. Mischnick

Address:

Schwegman, Lundberg & Woessner, P.A.

P.O. Box 2938

Minneapolis, MN 55402--0938

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41): \$ 0.00

☐ Enclosed

☐ Authorized to be charged to deposit account 19-0743

8. Please charge any additional fees or credit any over payments to our Deposit Account No.: 19-0743

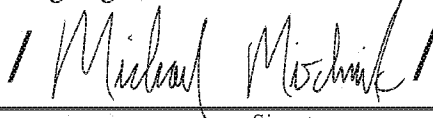
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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Michael R. Mischnick/Reg. No. 52,036

Name of Person Signing



Signature

February 27, 2014

Date

Total number of pages including cover sheet: 3

Mail documents to be recorded with required cover sheet information to:

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Mail Stop Assignment Recordation Services

P.O. Box 1450

Alexandria, VA 22313-1450

PATENT  
REEL: 032314 FRAME: 0844

## ASSIGNMENT

In consideration of good and valuable consideration, the receipt of which is hereby acknowledged, we, the undersigned inventor(s):

**Yonghao Xiu, Nisha Ananthakrishnan, Yiqun Bai, Arjun Krishnan**

hereby sell, assign, and transfer to:

**Intel Corporation**

a corporation of Delaware, having a principal place of business at 2200 Mission College Boulevard, Santa Clara, California, 95054 USA ("Assignee"), and its successors, assigns, and legal representatives, the entire right, title, and interest for the United States and all other countries, in and to any and all inventions and improvements that are disclosed in the application for the patent entitled:

### **NARROW-GAP FLIP CHIP UNDERFILL COMPOSITION**

(I hereby authorize and request any attorney having appropriate authority from the assignee to insert on the designated lines below, the filing date and application number of said application when known.)

which was filed on December 19, 2013 as

United States of America Application Number 14/135,236

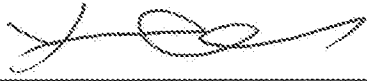
which has been executed by the undersigned prior hereto or concurrently herewith on the date(s) indicated below,

and in and to said application and all Additional Applications, and all other patent applications that have been or shall be filed in the United States and all other countries and international filing offices on any of said inventions and improvements; and in and to all original and reissued patents that have been or shall be issued in the United States and all other countries and international filing offices on said inventions and improvements; and in and to all rights of priority resulting from the filing of said applications; as used herein "Additional Applications" includes but is not limited to design, utility, utility model, divisional, continuing, continuation-in-part, substitute, renewal, reissue, and national phase applications on said inventions and improvements;

and agree that said Assignee may apply for and receive a patent or patents for said inventions and improvements in its own name; and that, when requested, without charge to, but at the expense of, said Assignee, its successors, assigns, and legal representatives, to carry out in good faith the intent and purpose of this Assignment, the undersigned will execute all Additional Applications, and all other patent applications on any and all said inventions and improvements; execute all rightful oaths, assignments, powers of attorney, and other papers; communicate to said Assignee, its successors, assigns, and legal representatives all facts known to the undersigned relating to said inventions and improvements and

the history thereof; and generally assist said Assignee, its successors, assigns, or legal representatives in securing and maintaining proper patent protection for said inventions and improvements and for vesting title to said inventions and improvements, and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns, and legal representatives; and

covenant with said Assignee, its successors, assigns, and legal representatives that no assignment, grant, mortgage, license, or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.



Yonghao Xiu

1/13/2014

Date Signed



Nisha Ananthakrishnan

01/15/14

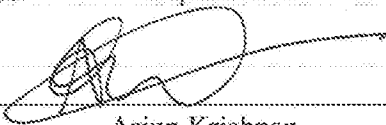
Date Signed



Yiqun Bai

1/14/2014

Date Signed



Arjun Krishnan

1/15/2014

Date Signed